HD74HC75

Quad. Bistable Latches

HITACHI

Description

This latch is ideally suited for use as temporary storage for binary information processing, input/output, and indicator units. Information present at the data (D) input is transferred to the Q output when the latch enable (LE) is high. The Q output will follow the data input as long as the enable remains high. when the enable goes low, the information that was present at the data input at the time the transition occurred is retained at thte Q output unit the enable is permitted to go high again.

Features

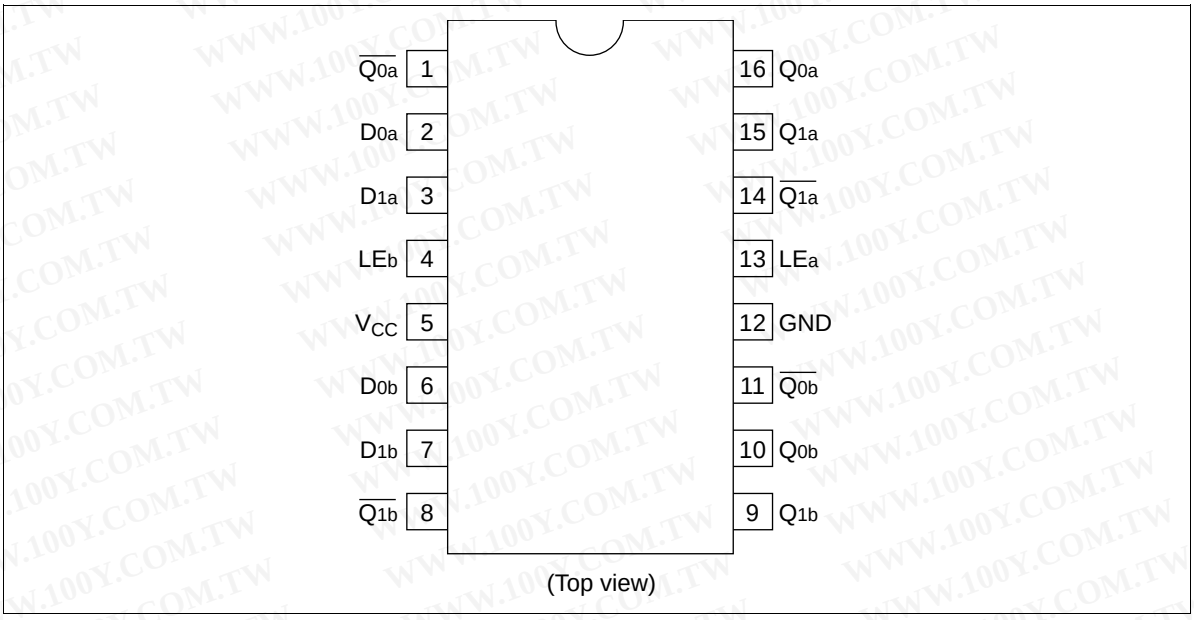
- High Speed Operation: t_{pd} (D to Q) = 12.5 ns typ (C_L = 50 pF)
- High Output Current: Fanout of 10 LSTTL Loads
- Wide Operating Voltage: V_{CC} = 2 to 6 V
- Low Input Current: 1 µA max
- Low Quiescent Supply Current: I_{CC} (static) = 2 µA max (Ta = 25°C)

Function Table

Inputs		Outputs	
D	**Latch Enable**	**Q**	$\overline{\mathbf{Q}}$
L	H	L	H
H	H	H	L
X	L	Q_0	$\overline{Q}_0$

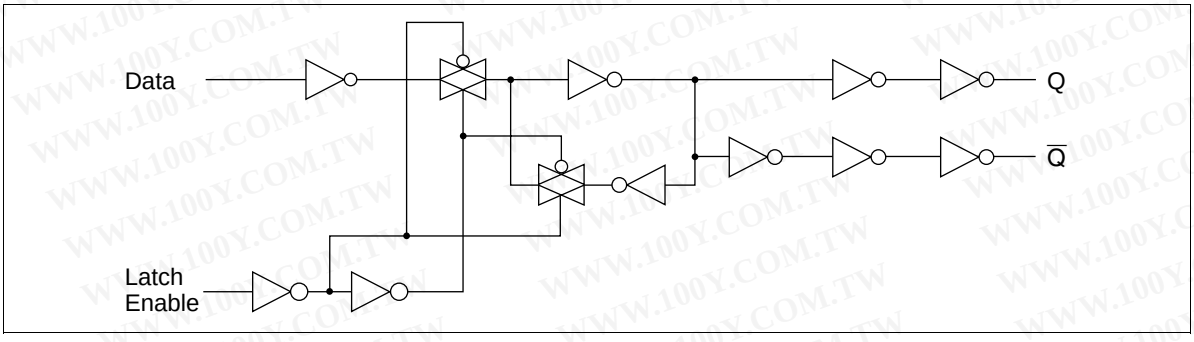
Hitachi semiconductor

Pin Arrangement



(Top view)

Block Diagram



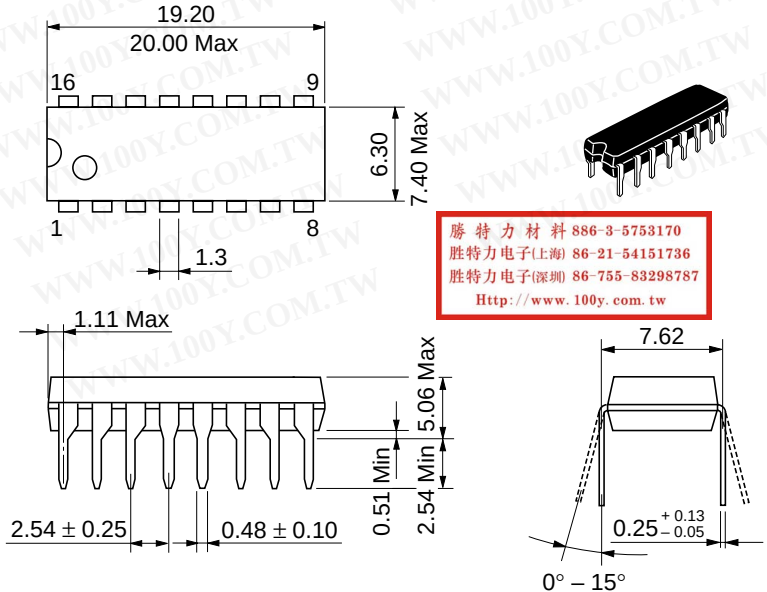
DC Characteristics

			Ta = 25°C			Ta = –40 to +85°C			
Item	**Symbol**	**V_{CC} (V)**	**Min**	**Typ**	**Max**	**Min**	**Max**	**Unit**	**Test Conditions**
Input voltage	V_{IH}	2.0	1.5	—	—	1.5	—	V	
		4.5	3.15	—	—	3.15	—		
		6.0	4.2	—	—	4.2	—		
	V_{IL}	2.0	—	—	0.5	—	0.5	V	
		4.5	—	—	1.35	—	1.35		
		6.0	—	—	1.8	—	1.8		
Output voltage	V_{OH}	2.0	1.9	2.0	—	1.9	—	V	Vin = V_{IH} or V_{IL} I_{OH} = –20 µA
		4.5	4.4	4.5	—	4.4	—		
		6.0	5.9	6.0	—	5.9	—		
		4.5	4.18	—	—	4.13	—		I_{OH} = –4 mA
		6.0	5.68	—	—	5.63	—		I_{OH} = –5.2 mA
	V_{OL}	2.0	—	0.0	0.1	—	0.1	V	Vin = V_{IH} or V_{IL} I_{OL} = 20 µA
		4.5	—	0.0	0.1	—	0.1		
		6.0	—	0.0	0.1	—	0.1		
		4.5	—	—	0.26	—	0.33		I_{OL} = 4 mA
		6.0	—	—	0.26	—	0.33		I_{OL} = 5.2 mA
Input current	Iin	6.0	—	—	±0.1	—	±1.0	µA	Vin = V_{CC} or GND
Quiescent supply current	I_{CC}	6.0	—	—	2.0	—	20	µA	Vin = V_{CC} or GND, Iout = 0 µA

AC Characteristics (C_L = 50 pF, Input t_r = t_f = 6 ns)

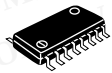
			Ta = 25°C			Ta = –40 to +85°C			
Item	**Symbol**	**V_{CC} (V)**	**Min**	**Typ**	**Max**	**Min**	**Max**	**Unit**	**Test Conditions**
Propagation delay time	t_{PLH}	2.0	—	—	125	—	155	ns	D to Q
	t_{PHL}	4.5	—	12	25	—	31		
		6.0	—	—	21	—	26		
		2.0	—	—	110	—	140		D to $\overline{Q}$
		4.5	—	13	22	—	28		
		6.0	—	—	19	—	24		
		2.0	—	—	145	—	180		Latch Enable to Q
		4.5	—	12	29	—	36		
		6.0	—	—	25	—	31		
		2.0	—	—	125	—	155		Latch Enable to $\overline{Q}$
		4.5	—	13	25	—	31		
		6.0	—	—	21	—	26		
Output rise/fall time	t_{TLH}	2.0	—	—	75	—	95	ns	
	t_{THL}	4.5	—	5	15	—	19		
		6.0	—	—	13	—	16		
Setup time	t_{su}	2.0	100	—	—	125	—	ns	Data to Latch Enable
		4.5	20	4	—	25	—		
		6.0	17	—	—	21	—		
Hold time	t_h	2.0	5	—	—	5	—	ns	Latch Enable to Data
		4.5	5	0	—	5	—		
		6.0	5	—	—	5	—		
Pulse width	t_w	2.0	80	—	—	100	—	ns	Latch Enable
		4.5	16	5	—	20	—		
		6.0	14	—	—	17	—		
Input capacitance	Cin	—	—	—	5	10	—	10	pF	

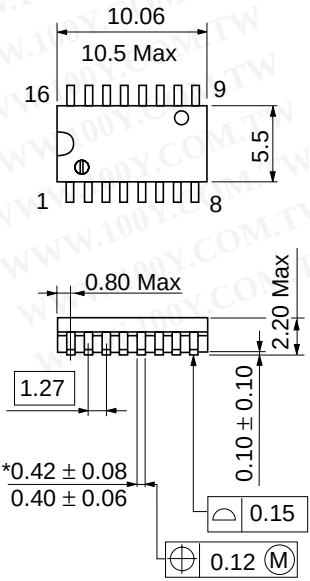
Unit: mm

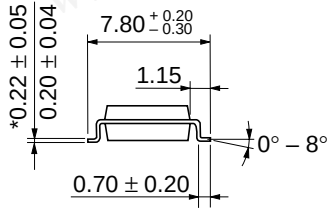


Hitachi Code	DP-16
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	1.07 g

Unit: mm



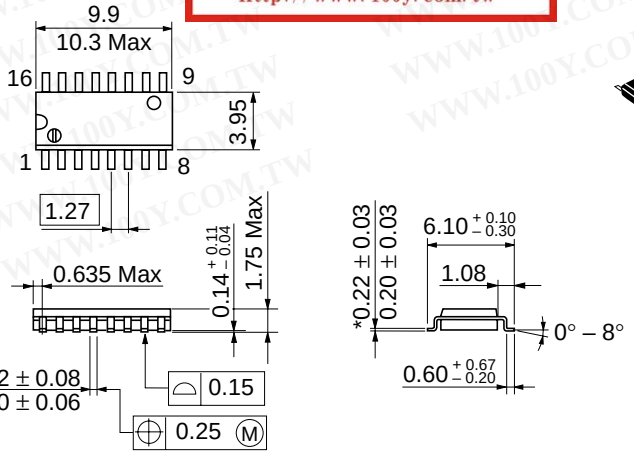


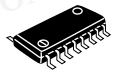


*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DA
JEDEC	—
EIAJ	Conforms
Weight (reference value)	0.24 g

Unit: mm





*Dimension including the plating thickness
Base material dimension

Hitachi Code	FP-16DN
JEDEC	Conforms
EIAJ	Conforms
Weight (reference value)	0.15 g

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